Product End-of-Life Disassembly Instructions

Product Category: Personal Computers

Marketing Name / Model
[List multiple models if applicable.]

HP Compaq Pro 4300 All-In-One Business PC

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.
1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

<table>
<thead>
<tr>
<th>Item Description</th>
<th>Notes</th>
<th>Quantity of items included in product</th>
</tr>
</thead>
<tbody>
<tr>
<td>Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)</td>
<td>With a surface greater than 10 sq cm MB &amp; Inverter Board</td>
<td>2</td>
</tr>
<tr>
<td>Batteries</td>
<td>All types including standard alkaline and lithium coin or button style batteries</td>
<td>5</td>
</tr>
<tr>
<td>Mercury-containing components</td>
<td>For example, mercury in lamps, display backlights, scanner lamps, switches, batteries</td>
<td>0</td>
</tr>
<tr>
<td>Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm</td>
<td>Includes background illuminated displays with gas discharge lamps LED Panel</td>
<td>1</td>
</tr>
<tr>
<td>Cathode Ray Tubes (CRT)</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Capacitors / condensers (Containing PCB/PCT)</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>External electrical cables and cords</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Gas Discharge Lamps</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Plastics containing Brominated Flame Retardants weighing &gt; 25 grams (not including PCBs or PCAs already listed as a separate item above)</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner</td>
<td>Include the cartridges, print heads, tubes, vent chambers, and service stations.</td>
<td>0</td>
</tr>
<tr>
<td>Components and waste containing asbestos</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Components, parts and materials containing refractory ceramic fibers</td>
<td></td>
<td>0</td>
</tr>
<tr>
<td>Components, parts and materials containing radioactive substances</td>
<td></td>
<td>0</td>
</tr>
</tbody>
</table>

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.
### Tool Description

<table>
<thead>
<tr>
<th>Tool Description</th>
<th>Tool Size (if applicable)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Electric screw driver</td>
<td>2# X10</td>
</tr>
<tr>
<td>Electric screw driver</td>
<td>1# X10</td>
</tr>
</tbody>
</table>

### 3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Please refer to the 3.2.2 disassemble hinge cover and stand
2. Please refer to the 3.2.3 disassemble R/L access door
3. Please refer to the 3.2.4 Remove rear cover
4. Please refer to the 3.2.5 disassemble HDD & ODD
5. Please refer to the 3.2.6 disassemble screw, CPU cover and stand shielding
6. Please refer to the 3.2.7 disassemble speaker
7. Please refer the 3.2.8/9 disassemble thermal module/system fan
8. Please refer to 3.2.10/11 disassemble converter board & power switch card
9. Please refer to 3.2.12 MB and battery of MB by clicking
10. Please refer to 3.2.13 Disassemble BASE pan& bezel
11. Please refer to 3.2.14 Remove Mouse/Keyboard Battery/MB
12. Please refer to 3.2.15 Remove power supply

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations)

**Figure 1 : Mechanical parts disassembly**

1) Place the system

2) Disassemble hinge cover & Disassemble stand
3) Disassemble R/L access door

4) Disassemble rear cover

Remove 5 screws for fixing main rear cover & Remove main rear cover

5) Disassemble HDD and ODD

Remove the screw of ODD cage and disassemble ODD then disassemble HDD

6) Disassemble screw, CPU cover and stand shielding

7) Disassemble speaker

Remove the screws of speaker and disassemble speaker

8) Disassemble CPU thermal module
9) Disassemble FAN

10) Disassemble Converter board

11) Disassemble the power switch card

12) Remove MB and battery of MB by clicking.

13) Disassemble BASE pan& bezel
14) Remove Mouse/Keyboard Battery/MB

Flip over the KB and mouse. You will find the batteries placement on the back of subject. Remove the batteries as the allow label shown.

15) Please refer to 3.2.15 Remove power supply